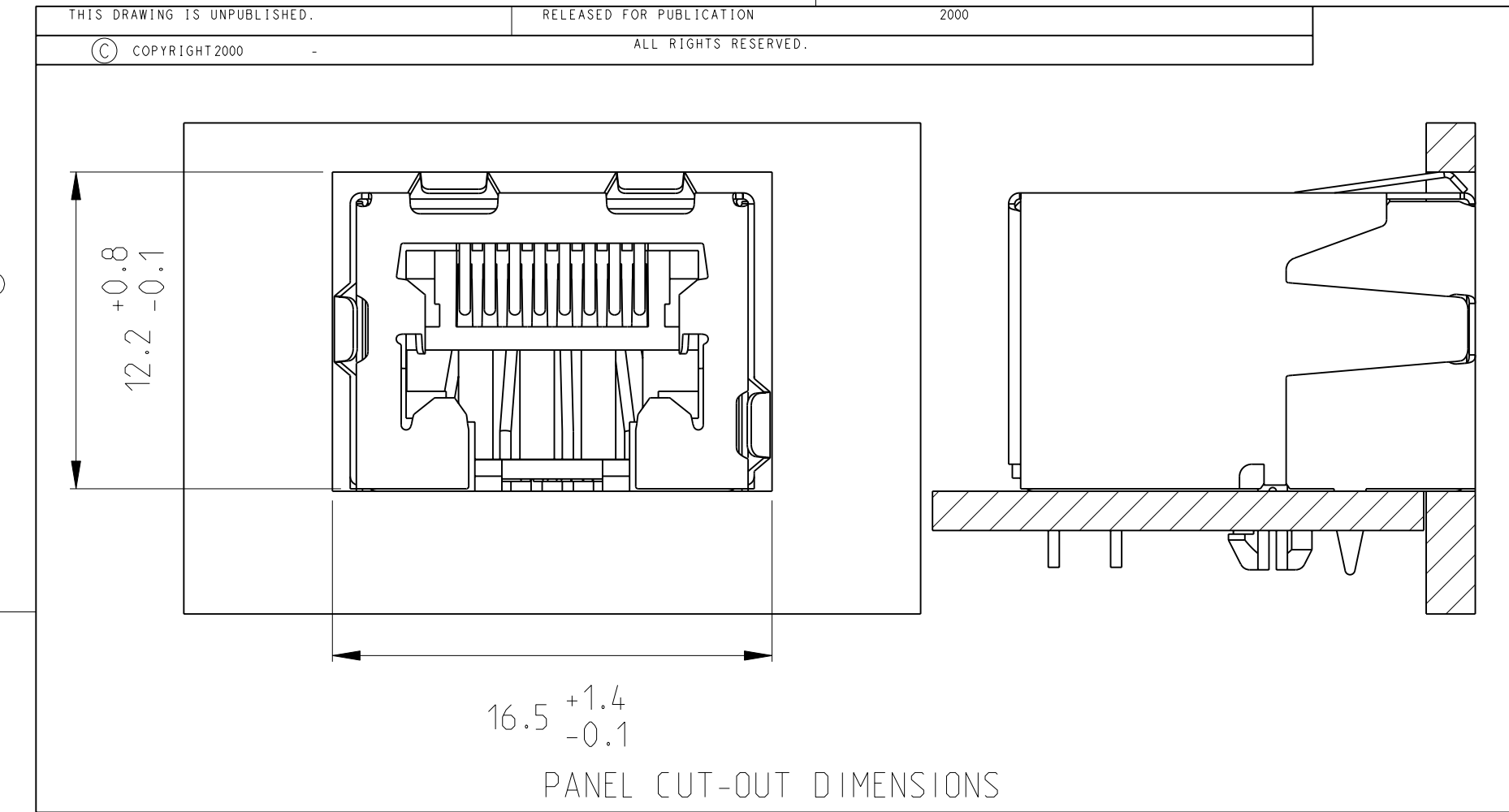
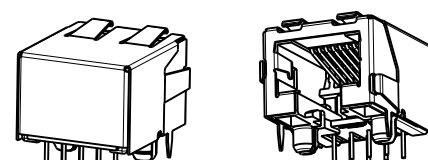
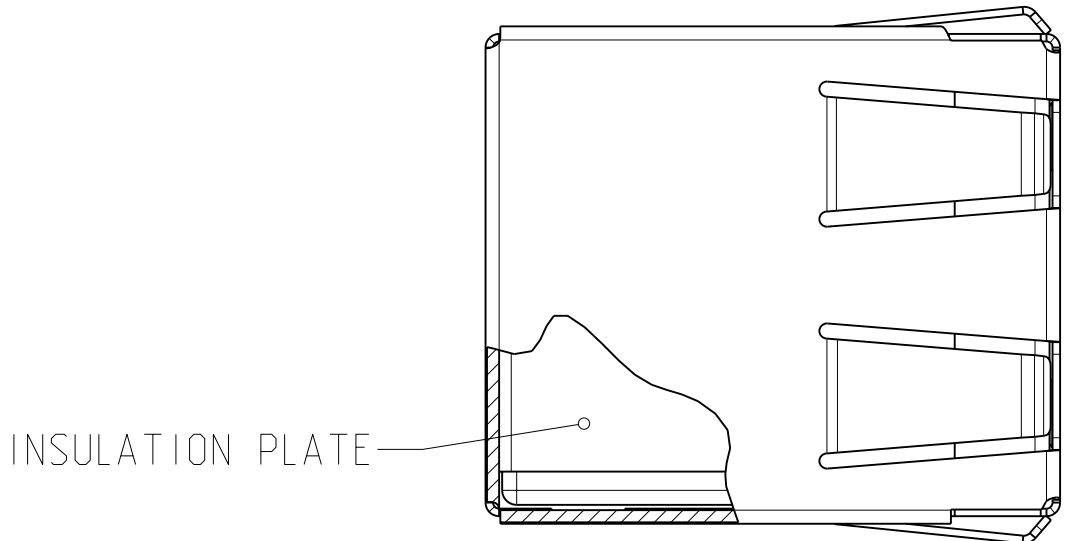
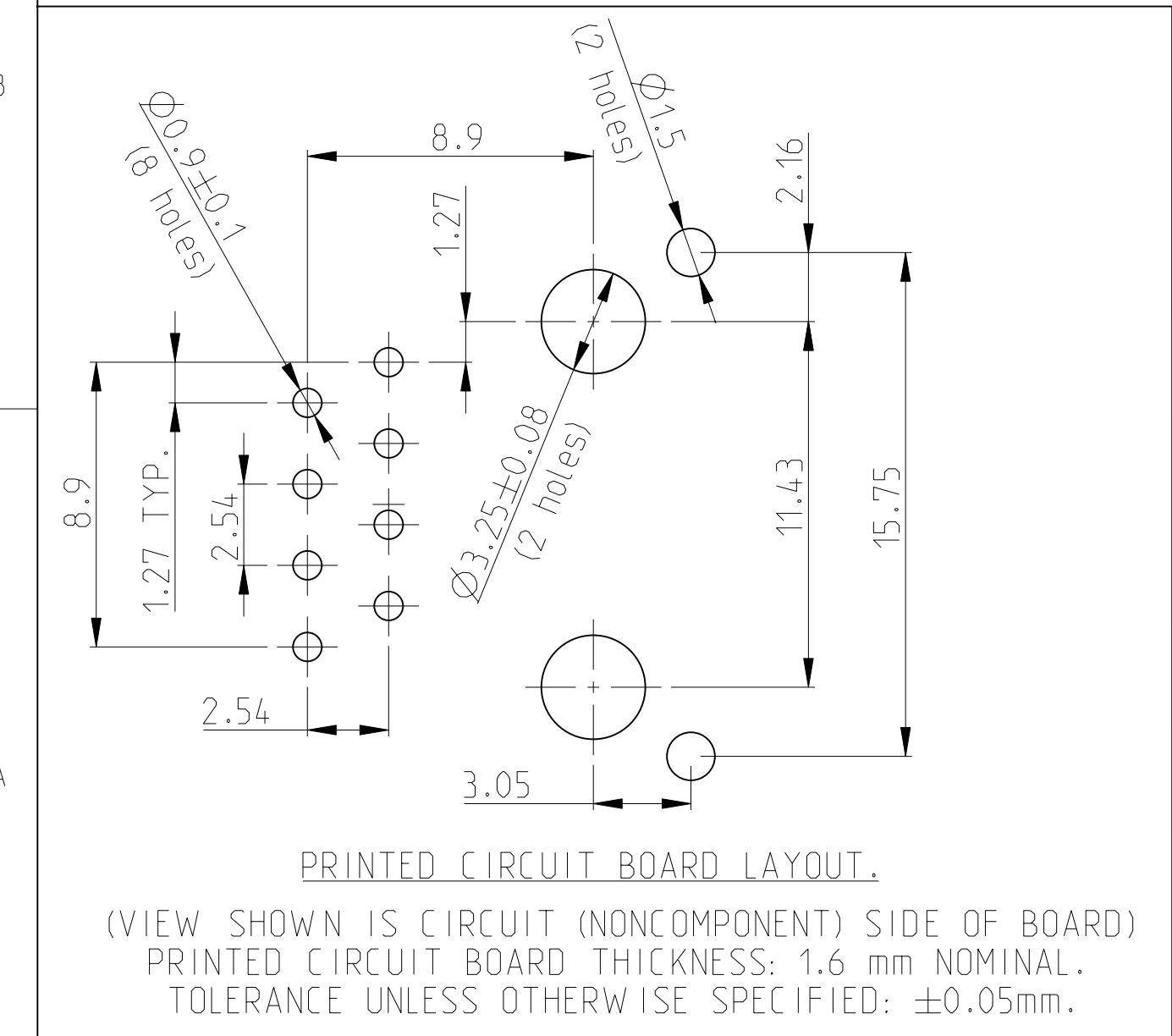
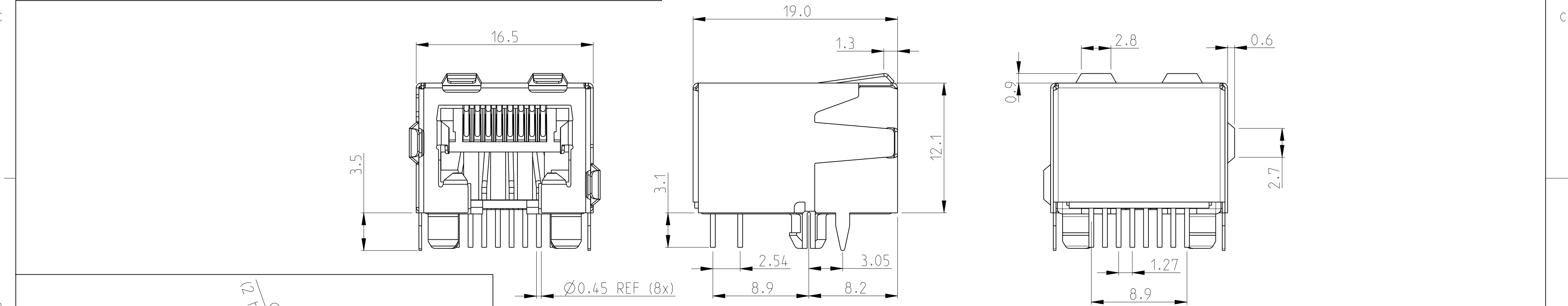
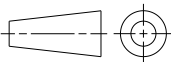




LOC	DIST	REVISIONS					
		P	LTR	DESCRIPTION	DATE	DWN	APVD
IR	-		J	ECR-10-020218	21JUN2011	PS	RRP
			K	SHIELD RAW MATERIAL CHANGE TO BRASS	08MAR2012	PS	RRP



SCALE: 1:1

PACKAGED 190 PIECES IN A TRAY	8 POS. 8 CONT.	OVERALL: Ni 1.27 μm MIN. ALL OVER THE CONTACTS	HOUSING: PBT UL 94 V-0 BLACK	2-338556-1
		SOLDER ZONE: Sn 2.5 μm MIN. ON THE SOLDER ZONE OF THE CONTACT	CONTACTS: PHOSPHOR BRONZE	
		MATING ZONE: PLATING CONFIRMS TO PRODUCT REQUIREMENTS AS PER SPECIFICATION 108-19064	SHIELD: BRASS PRE-PLATED (BRIGHT TIN)	
PACKAGING	REMARKS	DESCRIPTION	MATERIAL	P/N
THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN E.v.EIJK	 TE Connectivity	
		CHK M.v.ESSSEN		
DIMENSIONS: mm		APVD R.SMEETS	NAME 8 pos. Modular Jack Side Entry fully shielded with insulation plate	
		PRODUCT SPEC 108-19064		
		APPLICATION SPEC 114-19019		
		WEIGHT -		
MATERIAL -	FINISH -	CUSTOMER DRAWING	SCALE 4:1	SHEET 1 OF 2
			REV K	

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[TE Connectivity:](#)

[3-338556-1](#)